ASDCIATION CONNECTING ELECTRANCE INDUSTRIES® INCLUSTRIES	C. Bannockt	ourn. Illinois. A	Il rights reserved untions.	under both	This docume level parts, t	ent is a declarat	ion of the s encompasse	ubstances s all lowe	within the r level mat	manufacture erials for wh	er listed iter ich the mar	n. Note: nufacture	if the item is an as r has engineering	sembly with lower responsibility.	
	IPC Web Site for Information on IPC-1752 Standard For http://www.ipc.org/IPC-175x Dis				e * Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					eous Materia	ials and Mfg Information				
Supplier Information															
Company name* Comp			ompany unique ID			Unique ID Authority					Response Date*				
onsemi												2024-05-05			
Contact Name	ntact Name Title - Contact						Phone - Contact*				Email - Contact*				
Product-Env-Stewards Product Env			nviro Compliance			NA				Product-Env-Stewards@onsemi.com					
Authorized Representative* Title - Repr			presentative			Phone - Representative*				Email - Representative*					
Product-Env-Stewards Product E			act Enviro Compliance			NA				Product-Env-Stewards@onsemi.com					
Requester Item Number	Mfr Item	Number	Mfr Item Name			Effective Date	Version Manufacturing Site		ing Site	W	eight*	UOM	Unit Type		
	NCV769	4MW0R2G	N694 NCV7694 GRESHAM			2024-05-05		1	PHG		21	.121	mg	Each	
Manufacturing Proccess Information	ion														
Terminal Plating / Grid Array Ma	terial Terminal Base		Alloy	oy J-STD-020 MSL Ratin		Peak Proc	ess Body T	ss Body Temperature Max Time at Peak		me at Peak 🛛	Temperature Number of Reflow Cycles				
Matte Tin (Sn) - annealed CU Alloy		CU Alloy		1		260	60 C 3		30		seconds 3				
Comments															
evel 1 - maximum time at peak temperatu	re during so	dering is 10-3	0 seconds												
or more information regarding material	composition	please refer to	page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	(Pb), Mercury (Hg), Hexavalent Chror	oHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead b), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl thalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of							
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted								
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.												
Exemption List Version	EL-2011/534/EU											
Declaration Signature												
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the							
Supplier Digital Signature Ra	stislav Drska	Le										

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.566	mg	Supplier	Silicon (Si)	7440-21-3		0.566	mg
Die Attach	0.075	mg	Supplier	Isobornyl Methacrylate	7534-94-3		0.0045	mg
			Supplier	Silver (Ag)	7440-22-4		0.0611	mg
			Supplier	Isobornyl Acrylate	5888-33-5		0.0045	mg
			Supplier	Misc.	Proprietary Data		0.0004	mg
			Supplier	Tricyclo[5.2.1.02,6]decanedimethanol Diacrylate (C18H24O4)	42594-17-2		0.0045	mg
Lead Frame	10.737	mg	Supplier	Silver (Ag)	7440-22-4		0.2147	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0129	mg
			Supplier	Iron (Fe)	7439-89-6		0.2523	mg
			Supplier	Copper (Cu)	7440-50-8		10.2538	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0032	mg
Mold Compound-Black	9.092	mg		Epoxy resin	proprietary data		0.4546	mg
			Supplier	Phenolic Resin	Proprietary Data		0.2091	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.4546	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0364	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.2091	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		7.7282	mg
Plating	0.577	mg	Supplier	Tin (Sn)	7440-31-5		0.577	mg
Wire Bond - Au	0.074	mg	Supplier	Gold (Au)	7440-57-5		0.074	mg